

## P-Channel Enhancement Mode MOSFET

### RC2301A

#### Feature

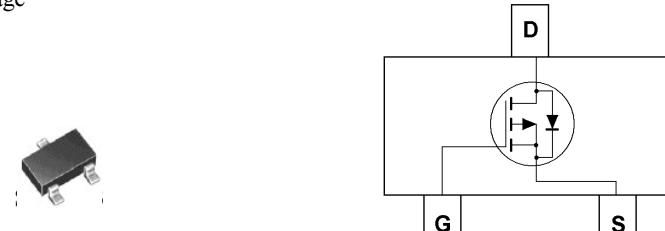
-20V/-3A, R<sub>DS(ON)</sub> = 120mΩ(MAX) @V<sub>GS</sub> = -4.5V.

R<sub>DS(ON)</sub> = 150mΩ(MAX) @V<sub>GS</sub> = -2.5V.

Super High dense cell design for extremely low R<sub>DS(ON)</sub>

Reliable and Rugged

SOT23 for Surface Mount Package



#### Applications

- Power Management

Portable Equipment and Battery Powered Systems.

#### Absolute Maximum Ratings

TA=25°C Unless Otherwise noted

| Parameter                | Symbol          | Limit | Units |
|--------------------------|-----------------|-------|-------|
| Drain-Source Voltage     | V <sub>DS</sub> | -20   | V     |
| Gate-Source Voltage      | V <sub>GS</sub> | ±10   | V     |
| Drain Current-Continuous | I <sub>D</sub>  | -3    | A     |

#### Electrical Characteristics

TA=25°C Unless Otherwise noted

| Parameter                                                     | Symbol              | Test Conditions                                            | Min  | Typ. | Max  | Units |
|---------------------------------------------------------------|---------------------|------------------------------------------------------------|------|------|------|-------|
| <b>Off Characteristics</b>                                    |                     |                                                            |      |      |      |       |
| Drain to Source Breakdown Voltage                             | BVDSS               | V <sub>GS</sub> =0V, I <sub>D</sub> =-250μA                | -20  | -    | -    | V     |
| Zero-Gate Voltage Drain Current                               | IDSS                | V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V                 | -    | -    | -1   | μA    |
| Gate Body Leakage Current, Forward                            | IGSSF               | V <sub>GS</sub> =10V, V <sub>DS</sub> =0V                  | -    | -    | 100  | nA    |
| Gate Body Leakage Current, Reverse                            | IGSSR               | V <sub>GS</sub> =-10V, V <sub>DS</sub> =0V                 | -    | -    | -100 | nA    |
| <b>On Characteristics</b>                                     |                     |                                                            |      |      |      |       |
| Gate Threshold Voltage                                        | V <sub>GS(th)</sub> | V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> =-250μA | -0.4 | -    | -1.0 | V     |
| Static Drain-source                                           | R <sub>DS(ON)</sub> | V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-3.0A              | -    | --   | 120  | mΩ    |
| On-Resistance                                                 |                     | V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-2.0A              | -    | --   | 150  | mΩ    |
| <b>Drain-Source Diode Characteristics and Maximum Ratings</b> |                     |                                                            |      |      |      |       |
| Drain-Source Diode Forward Voltage                            | V <sub>SD</sub>     | V <sub>GS</sub> =0V, I <sub>S</sub> =-1.25A                |      |      | -1.2 | V     |

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### Typical Characteristics

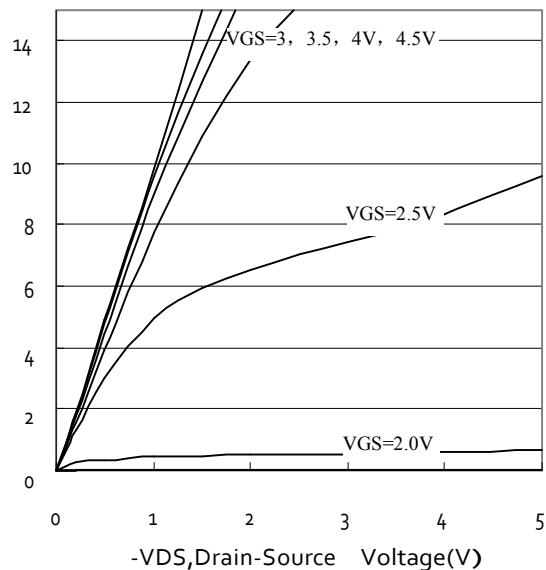


Figure 1. Output Characteristics

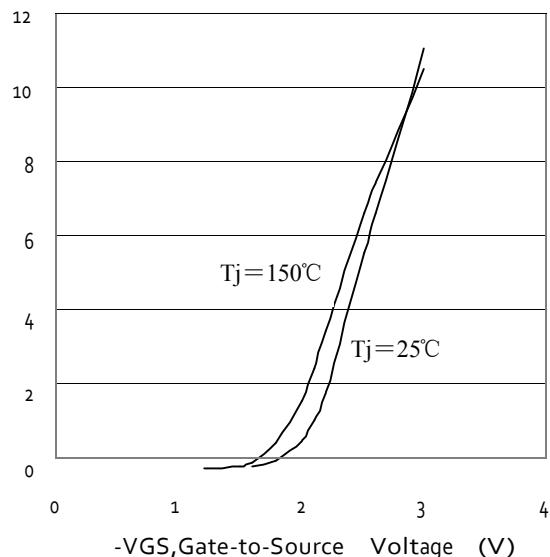


Figure 2. Transfer Characteristics

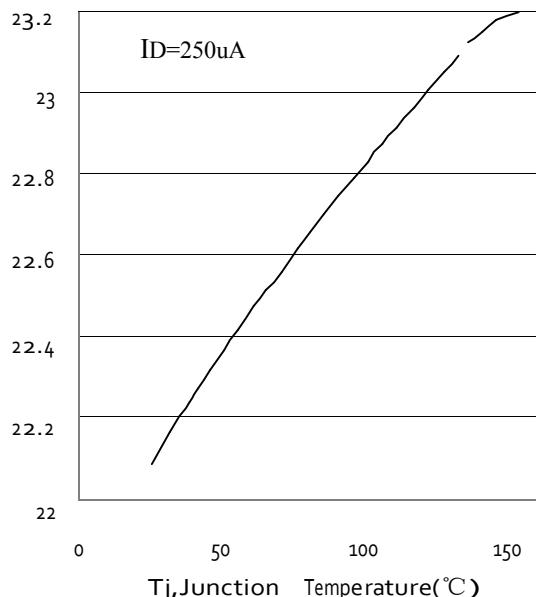


Figure 3. Breakdown Voltage Variation with Temperature

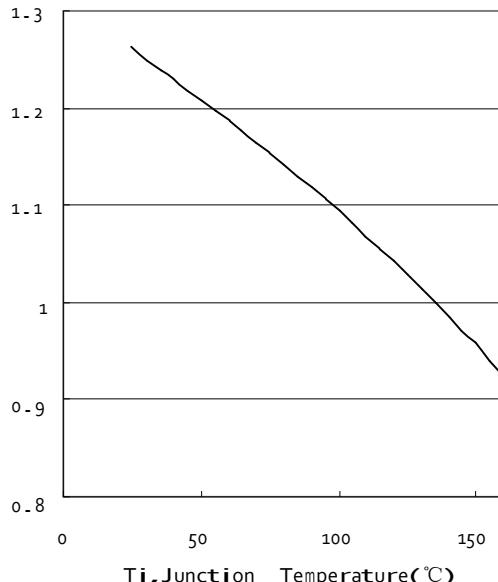
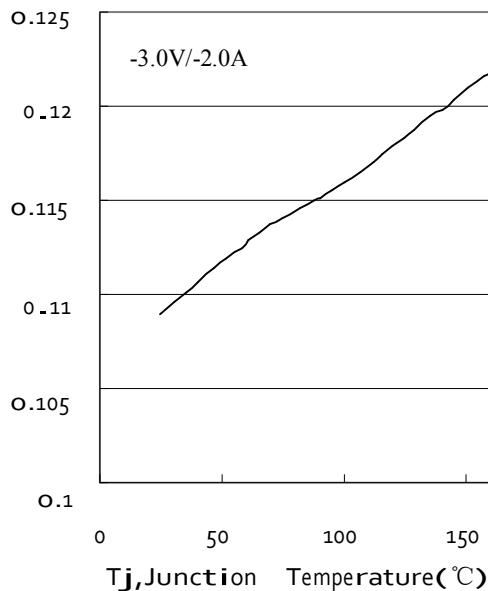


Figure 4. Gate Threshold Variation with Temperature

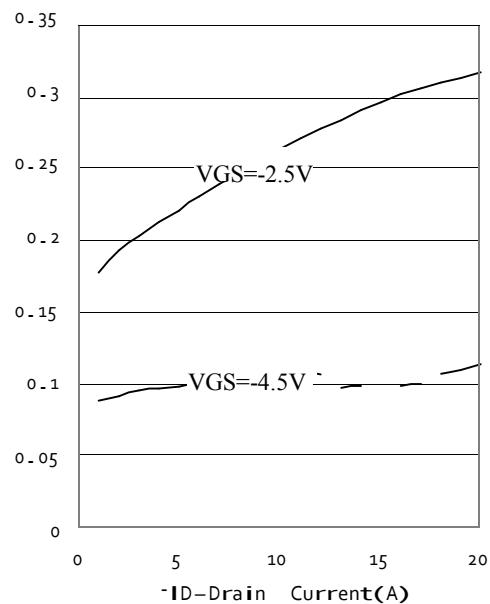
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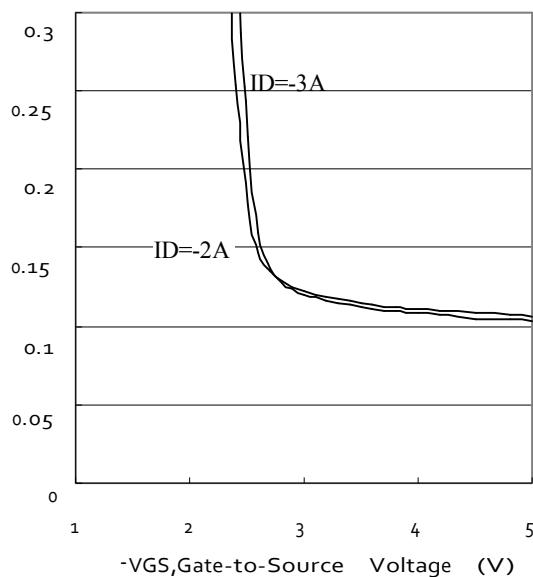
#### Typical Characteristics



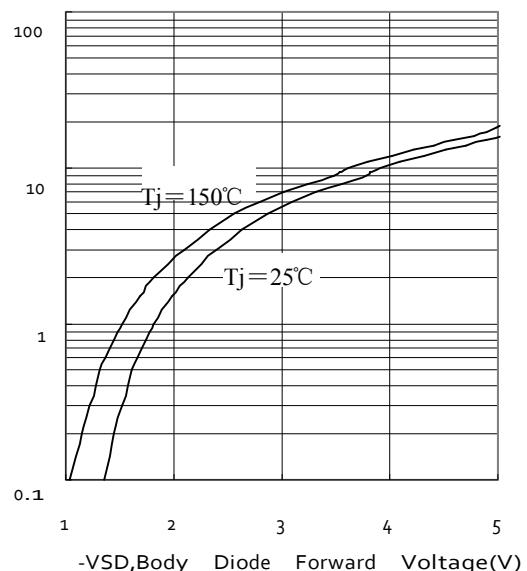
**Figure 5.** On-Resistance Variation  
with Temperature



**Figure 6.** On-Resistance vs. Drain Current



**Figure 7 .** On-Resistance vs. Gate-to-Source  
Voltage



**Figure 8 .** Source-Drain Diode Forward  
Voltage